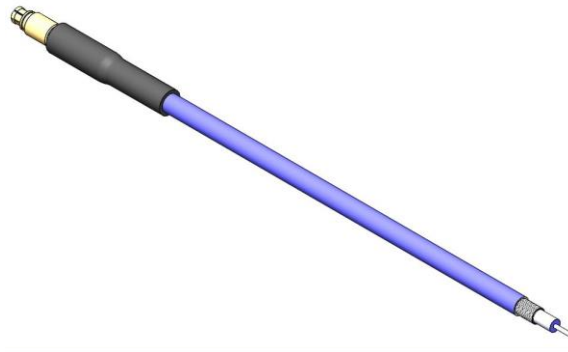
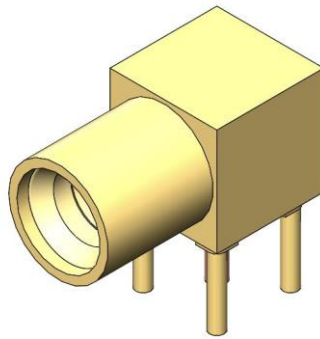




| | |
|---|-------------------------------------|
| Project Number: Design Qualification Test Report | Tracking Code: 2296172_Report_Rev_1 |
| Requested by: Tim Clare | Date: 6/15/2020 |
| Part #: SMPM-PF-P-HF-RA-TH-1/RF23C-M0SJ-303030-0153 | Tech: Tony Wagoner |
| Part description: SMPM / RF23C | Qty to test: 20 |
| Test Start: 03/10/2020 | Test Completed: 04/06/2020 |



DESIGN QUALIFICATION TEST REPORT

SMPM / RF23C
SMPM-PF-P-HF-RA-TH-1/RF23C-M0SJ-303030-0153

REVISION HISTORY

| DATA | REV.NUM. | DESCRIPTION | ENG |
|-------------|-----------------|--------------------|------------|
| 5/8/2020 | 1 | Initial Issue | PC |

CERTIFICATION

All instruments and measuring equipment were calibrated to National Institute for Standards and Technology (NIST) traceable standards according to ISO 10012-1 and ANSI/NCSL 2540-1, as applicable.

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SCOPE

To perform the following tests: Design Qualification test. Please see test plan.

APPLICABLE DOCUMENTS

Standards: EIA Publication 364

TEST SAMPLES AND PREPARATION

- 1) All materials were manufactured in accordance with the applicable product specification.
- 2) All test samples were identified and encoded to maintain traceability throughout the test sequences.
- 3) Either an automated cleaning procedure or an ultrasonic cleaning procedure may be used.
- 4) The automated procedure is used with aqueous compatible soldering materials.
- 5) Parts not intended for testing LLCR and DWV/IR are visually inspected and cleaned if necessary.
- 6) Any additional preparation will be noted in the individual test sequences.
- 7) Solder Information: Lead free
- 8) Samtec Test PCBs used: PCB-110799-TST.

FLOWCHARTS

IR/DWV

Note: 5000 megaohms min IR

Pin-to-Ground

Group 1

SMPM-PF-P-HF-RA-TH-1
RF23C-M0SJ-303030-0153
2 Assemblies

| Step | Description |
|------|-------------------|
| 1. | DWV Breakdown (2) |

Group 2

SMPM-PF-P-HF-RA-TH-1
2 Assemblies

| Step | Description |
|------|-------------------|
| 1. | DWV Breakdown (2) |

Group 3

SMPM-PF-P-HF-RA-TH-1
RF23C-M0SJ-303030-0153
2 Assemblies

| Step | Description |
|------|----------------------------------|
| 1. | IR (4) |
| 2. | DWV at Test Voltage (1) |
| 3. | Thermal Shock (5) - Non Standard |
| 4. | IR (4) |
| 5. | DWV at Test Voltage (1) |
| 6. | Humidity (3) |
| 7. | IR (4) |
| 8. | DWV at Test Voltage (1) |

-
- (1) DWV at Test Voltage = EIA-364-20
Test Condition = 1 (Sea Level)
DWV test voltage is equal to 75% of the lowest breakdown voltage
Test voltage applied for 60 seconds
- (2) DWV Breakdown = EIA-364-20
Test Condition = 1 (Sea Level)
DWV test voltage is equal to 75% of the lowest breakdown voltage
Test voltage applied for 60 seconds
- (3) Humidity = EIA-364-31
Test Condition = B (240 Hours)
Test Method = III (+25°C to +65°C @ 90% RH to 98% RH)
Test Exceptions: ambient pre-condition and delete steps 7a and 7b
- (4) IR = EIA-364-21
Test Condition = 500 Vdc, 2 Minutes Max
- (5) Thermal Shock = Other
Exposure Time at Temperature Extremes = 1/2 Hour
Method A, Test Condition = I (-55°C to +125°C)
Test Duration = A-3 (100 Cycles)

FLOWCHARTS Continued**Mechanical Shock/Random Vibration/LLCR***Note: Check signal and ground LLCR.***Group 1**

SMPM-PF-P-HF-RA-TH-1

RF23C-M0SJ-303030-0305

8 Assemblies

Step Description

1. LLCR ⁽¹⁾
2. Mechanical Shock ⁽²⁾ - Non Standard
3. Random Vibration ⁽³⁾
4. LLCR ⁽¹⁾
Max Delta = 15 mOhm

(1) LLCR = EIA-364-23

Open Circuit Voltage = 20 mV Max

Test Current = 100 mA Max

(2) Mechanical Shock = Other

Test Condition = G (100 G Peak, 6 milliseconds, Sawtooth, 3 shocks per axis)

EIA-364-27

(3) Random Vibration = EIA-364-28

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

Mechanical Shock/Random Vibration/Event Detection**Group 1**

SMPM-PF-P-HF-RA-TH-1

RF23C-M0SJ-303030-0305

60 Points

Step Description

1. Nanosecond Event Detection
(Mechanical Shock) ⁽¹⁾ - Non Standard
2. Nanosecond Event Detection
(Random Vibration) ⁽²⁾

(1) Nanosecond Event Detection (Mechanical Shock) = Other

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-27 for Mechanical Shock:

Test Condition = G (100 G Peak, 6 milliseconds, Sawtooth, 3 shocks per axis)

(2) Nanosecond Event Detection (Random Vibration)

Use EIA-364-87 for Nanosecond Event Detection:

Test Condition = F (50 nanoseconds at 10 ohms)

Use EIA-364-28 for Random Vibration:

Condition = VB (7.56 gRMS Average, 2 Hours/Axis)

ATTRIBUTE DEFINITIONS

The following is a brief, simplified description of attributes.

THERMAL SHOCK:

- 1) EIA-364-32, *Thermal Shock (Temperature Cycling) Test Procedure for Electrical Connectors*.
- 2) Test Condition 1: -55°C to +125°C
- 3) Test Time: ½ hour dwell at each temperature extreme
- 4) Number of Cycles: 100
- 5) All test samples are pre-conditioned at ambient.
- 6) All test samples are exposed to environmental stressing in the mated condition.

HUMIDITY:

- 1) Reference document: EIA-364-31, *Humidity Test Procedure for Electrical Connectors*.
- 2) Test Condition B, 240 Hours.
- 3) Method III, +25° C to + 65° C, 90% to 98% Relative Humidity excluding sub-cycles 7a and 7b.
- 4) All samples are pre-conditioned at ambient.
- 5) All test samples are exposed to environmental stressing in the mated condition.

MECHANICAL SHOCK (Specified Pulse):

- 1) Reference document: EIA-364-27, *Mechanical Shock Test Procedure for Electrical Connectors*
- 2) Test Condition C
- 3) Peak Value: 100 G
- 4) Duration: 6 Milliseconds
- 5) Wave Form: Sawtooth.
- 6) Velocity: 12.3 ft/s
- 7) Number of Shocks: 3 Shocks / Direction, 3 Axis (18 Total)

VIBRATION:

- 1) Reference document: EIA-364-28, *Vibration Test Procedure for Electrical Connectors*
- 2) Test Condition V, Letter B
- 3) Power Spectral Density: 0.04 G² / Hz
- 4) G 'RMS': 7.56
- 5) Frequency: 50 to 2000 Hz
- 6) Duration: 2.0 Hours per axis (3 axis total)

NANOSECOND-EVENT DETECTION:

- 1) Reference document: EIA-364-87, *Nanosecond-Event Detection for Electrical Connectors*
- 2) Prior to test, the samples were characterized to assure the low nanosecond event being monitored will trigger the detector.
- 3) After characterization it was determined the test samples could be monitored for 50 nanosecond events

LLCR:

- 1) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 2) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 3) The following guidelines are used to categorize the changes in LLCR as a result from stressing
 - a. <= +5.0 mOhms:----- Stable
 - b. +5.1 to +10.0 mOhms:----- Minor
 - c. +10.1 to +15.0 mOhms:----- Acceptable
 - d. +15.1 to +50.0 mOhms:----- Marginal
 - e. +50.1 to +1000 mOhms:----- Unstable
 - f. >+1000 mOhms:----- Open Failure

ATTRIBUTE DEFINITIONS Continued

The following is a brief, simplified description of attributes.

INSULATION RESISTANCE (IR):

To determine the resistance of insulation materials to leakage of current through or on the surface of these materials when a DC potential is applied.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-21, *Insulation Resistance Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Electrification Time 2.0 minutes
 - iii. Test Voltage (500 VDC) corresponds to calibration settings for measuring resistances.
- 2) MEASUREMENTS:
- 3) When the specified test voltage is applied (VDC), the insulation resistance shall not be less than 5000 megohms.

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

To determine if the sockets can operate at its rated voltage and withstand momentary over potentials due to switching, surges, and other similar phenomenon. Separate samples are used to evaluate the effect of environmental stresses so not to influence the readings from arcing that occurs during the measurement process.

- 1) PROCEDURE:
 - a. Reference document: EIA-364-20, *Withstanding Voltage Test Procedure for Electrical Connectors*.
 - b. Test Conditions:
 - i. Between Adjacent Contacts or Signal-to-Ground
 - ii. Barometric Test Condition 1
 - iii. Rate of Application 500 V/Sec
 - iv. Test Voltage (VAC) until breakdown occurs
- 2) MEASUREMENTS/CALCULATIONS
 - a. The dielectric withstanding voltage shall be recorded as 750VAC.

The working voltage shall be recorded as one-third (1/3) of the dielectric withstanding voltage (one-fourth of the breakdown voltage).

RESULTS**Insulation Resistance minimums, IR****Pin to Ground**

- **Initial**
 - Mated -----45000 Meg Ω ----- Passed
 - Unmated -----45000 Meg Ω ----- Passed
- **Thermal Shock**
 - Mated -----45000 Meg Ω ----- Passed
 - Unmated -----45000 Meg Ω ----- Passed
- **Humidity**
 - Mated -----45000 Meg Ω ----- Passed
 - Unmated -----45000 Meg Ω ----- Passed

Dielectric Withstanding Voltage minimums, DWV

- **Minimums**
 - Breakdown Voltage ----- 1070 VAC
 - Test Voltage -----805 VAC
 - Working Voltage -----265 VAC

Pin to Ground

- **Initial DWV** -----Passed
- **Thermal DWV**-----Passed
- **Humidity DWV**-----Passed

LLCR Shock & Vibration Group (16 LLCR test points)**Signal pin**

- **Initial** ----- 23.57 mOhms Max

Ground Pin

- **Initial** ----- 10.42 mOhms Max

Shock &Vibration

- $\leq +5.0$ mOhms ----- 16 Points ----- Stable
- $+5.1$ to $+10.0$ mOhms -----0 Points ----- Minor
- $+10.1$ to $+15.0$ mOhms -----0 Points ----- Acceptable
- $+15.1$ to $+50.0$ mOhms -----0 Points ----- Marginal
- $+50.1$ to $+1000$ mOhms-----0 Points ----- Unstable
- $>+1000$ mOhms -----0 Points ----- Open Failure

Mechanical Shock & Random Vibration:

- **Shock**
 - **No Damage**----- Passed
 - **50 Nanoseconds**----- Passed
- **Vibration**
 - **No Damage**----- Passed
 - **50 Nanoseconds**----- Passed

DATA SUMMARIES**INSULATION RESISTANCE (IR):**

| | Pin to Pin | | |
|-----------------|-------------------|-------------|--------------|
| | Mated | Unmated | Unmated |
| Minimum | SMPM/RF23C | SMPM | RF23C |
| Initial | 45000 | 45000 | 45000 |
| Thermal | 45000 | 45000 | 45000 |
| Humidity | 45000 | 45000 | 45000 |

DIELECTRIC WITHSTANDING VOLTAGE (DWV):

| Voltage Rating Summary | |
|-------------------------------|-------------------|
| Minimum | SMPM/RF23C |
| Break Down Voltage | 1070 |
| Test Voltage | 805 |
| Working Voltage | 265 |

| Pin to Ground | |
|------------------------------------|--------|
| Initial Test Voltage | Passed |
| After Thermal Test Voltage | Passed |
| After Humidity Test Voltage | Passed |

DATA SUMMARIES Continued**LLCR Shock & Vibration Group**

- 1) A total of 16 points were measured.
- 2) EIA-364-23, *Low Level Contact Resistance Test Procedure for Electrical Connectors and Sockets*.
- 3) A computer program, *LLCR 221.exe*, ensures repeatability for data acquisition.
- 4) The following guidelines are used to categorize the changes in LLCR as a result from stressing.
 - a. $\leq +5.0$ mOhms: ----- Stable
 - b. $+5.1$ to $+10.0$ mOhms: ----- Minor
 - c. $+10.1$ to $+15.0$ mOhms: ----- Acceptable
 - d. $+15.1$ to $+50.0$ mOhms: ----- Marginal
 - e. $+50.1$ to $+1000$ mOhms ----- Unstable
 - f. $>+1000$ mOhms: ----- Open Failure

| LLCR Measurement Summaries by Pin Type | | | |
|---|----------------|------------------|--|
| Date | 3/19/2020 | 4/6/2020 | |
| Room Temp (Deg C) | 22 | 23 | |
| Rel Humidity (%) | 48 | 43 | |
| Technician | Tony Wagoner | Tony Wagoner | |
| mOhm values | Actual | Delta | |
| | Initial | Shock-Vib | |
| Pin Type: Signal 1 | | | |
| Average | 23.4 | 0.17 | |
| St. Dev. | 0.13 | 0.19 | |
| Min | 23.15 | 0 | |
| Max | 23.57 | 0.57 | |
| Summary Count | 8 | 8 | |
| Total Count | 8 | 8 | |
| Pin Type: GND 1 | | | |
| Average | 10.23 | 0.63 | |
| St. Dev. | 0.17 | 0.13 | |
| Min | 9.98 | 0.45 | |
| Max | 10.42 | 0.9 | |
| Summary Count | 8 | 8 | |
| Total Count | 8 | 8 | |

| LLCR Delta Count by Category | | | | | | |
|-------------------------------------|----------------------------|--|---|---|---|------------------------------|
| | Stable | Minor | Acceptable | Marginal | Unstable | Open |
| mOhms | ≤ 5 | >5 & ≤ 10 | >10 & ≤ 15 | >15 & ≤ 50 | >50 & ≤ 1000 | >1000 |
| Shock-Vib | 16 | 0 | 0 | 0 | 0 | 0 |

DATA SUMMARIES Continued**Nanosecond Event Detection:**

| Shock and Vibration Event Detection Summary | |
|--|--------------------------|
| Contacts tested | 16 |
| Test Condition | G, 100g's, 6ms, Sawtooth |
| Shock Events | 0 |
| Test Condition | V-B, 7.56 rms g |
| Vibration Events | 0 |
| Total Events | 0 |

EQUIPMENT AND CALIBRATION SCHEDULES**Equipment #:** MO-11**Description:** Switch/Multimeter**Manufacturer:** Keithley**Model:** 3706**Serial #:** 120169**Accuracy:** See Manual

... Last Cal: 09/11/2019, Next Cal: 09/11/2020

Equipment #: THC-05**Description:** Temperature/Humidity Chamber (Chamber Room)**Manufacturer:** Thermotron**Model:** SM-8-3800**Serial #:** 05 23 00 02**Accuracy:** See Manual

... Last Cal: 11/14/2019, Next Cal: 05/31/2020

Equipment #: TSC-01**Description:** Vertical Thermal Shock Chamber**Manufacturer:** Cincinnati Sub Zero**Model:** VTS-3-6-6-SC/AC**Serial #:** 10-VT14993**Accuracy:** See Manual

... Last Cal: 06/30/2019, Next Cal: 06/30/2020

Equipment #: HPT-01**Description:** Hipot Safety Tester**Manufacturer:** Vitrek**Model:** V73**Serial #:** 019808**Accuracy:**

... Last Cal: 05/15/2019, Next Cal: 05/15/2020

Equipment #: SVC-01**Description:** Shock & Vibration Table**Manufacturer:** Data Physics**Model:** LE-DSA-10-20K**Serial #:** 10037**Accuracy:** See Manual

... Last Cal: 04/22/2020, Next Cal: 04/22/2021

EQUIPMENT AND CALIBRATION SCHEDULES**Equipment #:** ACLM-01**Description:** Accelerometer**Manufacturer:** PCB Piezotronics**Model:** 352C03**Serial #:** 115819**Accuracy:** See Manual

... Last Cal: 07/18/2019, Next Cal: 07/18/2020

Equipment #: ED-03**Description:** Event Detector**Manufacturer:** Analysis Tech**Model:** 32EHD**Serial #:** 1100604**Accuracy:** See Manual

... Last Cal: 10/31/2019, Next Cal: 10/31/2020